

P-CHANNEL ENHANCEMENT MODE MOSFET WITH INTEGRATED SBR

Features

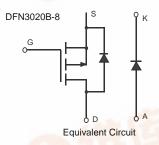
- Low On-Resistance
 - $95m\Omega @V_{GS} = -4.5V$
 - 120mΩ @V_{GS} = -2.5V
 - 150mΩ (typ) @ $V_{GS} = -1.8V$
- Low Gate Threshold Voltage, -1.3V Max
- Fast Switching Speed
- Low Input/Output Leakage
- Incorporates Low V_F Super Barrier Rectifier (SBR)
- Low Profile, 0.5mm Max Height
- Lead Free/RoHS Compliant (Note 2)
- "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

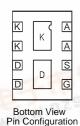
Mechanical Data

- Case: DFN3020B-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminal Connections: See Diagram
- Terminals: Finish NiPdAu annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 5
- Ordering Information: See Page 5
- Weight: 0.011 grams (approximate)









Top View

Bottom View

Maximum Ratings – TOTAL DEVICE @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 1)	P_{D}	1.5	W
Thermal Resistance, Junction to Ambient	$R_{ hetaJA}$	85	°C/W
Operating and Storage Temperature Range	T_J , T_{STG}	-55 to +150	°C

Maximum Ratings – P-CHANNEL MOSFET – Q1 @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Units
Drain-Source Voltage	V _{DSS}	-20	V
Gate-Source Voltage	V _{GSS}	±12	V
Drain Current (Note 1)	I _D	-2.9	Α
Pulsed Drain Current (Note 4)	I _{DM}	-10	A

Maximum Ratings - SBR - D1 @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	40	V
RMS Reverse Voltage	V _{R(RMS)}	28	V
Average Rectified Output Current	lo	F1 707	Α
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	3	А

Device mounted on FR-4 PCB, on minimum recommended, 2oz Copper pad layout. Notes:

No purposefully added lead.

Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.

Repetitive rating, pulse width limited by junction temperature.



Electrical Characteristics – P-CHANNEL MOSFET – Q1 @TA = 25°C unless otherwise specified

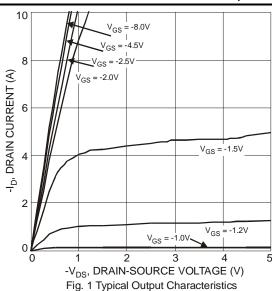
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 5)	Cymbol		קני	Mux	Oiiii	rest condition
Drain-Source Breakdown Voltage	BV _{DSS}	-20	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current	I _{DSS}		_	-1	μΑ	V _{DS} = -20V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	_	_	±100 ±800	nA	$V_{GS} = \pm 8V, V_{DS} = 0V$ $V_{GS} = \pm 12V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 5)						
Gate Threshold Voltage	V _{GS(th)}	-0.45	_	-1.3	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
Static Drain-Source On-Resistance	R _{DS (ON)}	_	70 84	95 120	mΩ	$V_{GS} = -4.5V$, $I_D = -2.8A$ $V_{GS} = -2.5V$, $I_D = -2.0A$
Forward Transfer Admittance	Y _{fs}	_	100 8	150 —	S	$V_{GS} = -1.8V$, $I_{D} = -1.0A$ $V_{DS} = -5V$, $I_{D} = -2.8A$
Diode Forward Voltage (Note 5)	V_{SD}		0.42	-1.2	V	$V_{GS} = 0V, I_{S} = -1.0A$
DYNAMIC CHARACTERISTICS						
Input Capacitance	C _{iss}		632	_	pF	10/ 10/ 1/ 01/
Output Capacitance	Coss		65		pF	V _{DS} = -10V, V _{GS} = 0V f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	_	54	_	pF	= 1.0

Electrical Characteristics – SBR – D1 @ T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 5)	$V_{(BR)R}$	40			V	$I_R = 1mA$
Forward Voltage	V _F	_		0.42	V	$I_F = 0.5A$
Polward Voltage			_	0.49		$I_F = 1.0A$
Reverse Current (Note 5)	I _R	_	_	30	μΑ	$V_R = 20V$

Notes: 5. Short duration pulse test used to minimize self-heating effect.

Q1, P-CHANNEL MOSFET



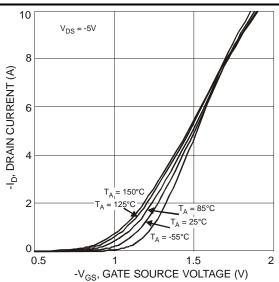
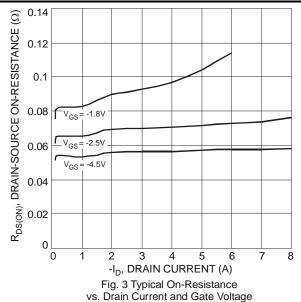
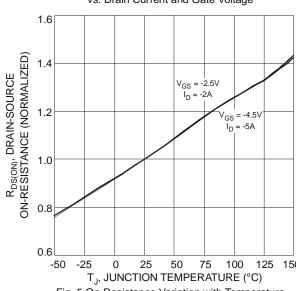


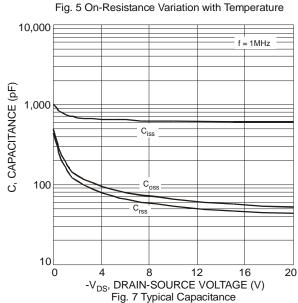
Fig. 2 Typical Transfer Characteristics



Q1, P-CHANNEL MOSFET - Continued







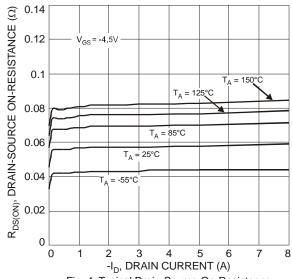


Fig. 4 Typical Drain-Source On-Resistance vs. Drain Current and Temperature

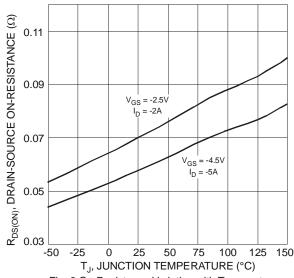


Fig. 6 On-Resistance Variation with Temperature

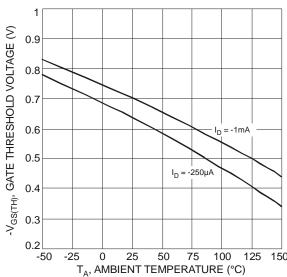
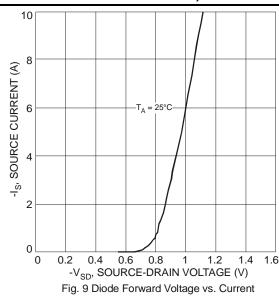


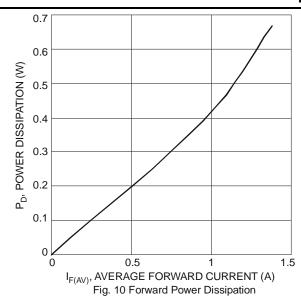
Fig. 8 Gate Threshold Variation vs. Ambient Temperature

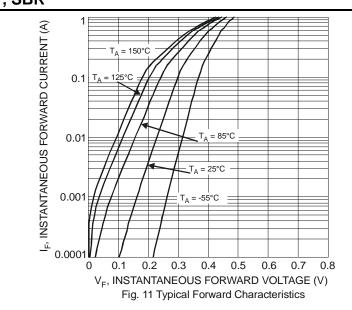


Q1, P-CHANNEL MOSFET - Continued



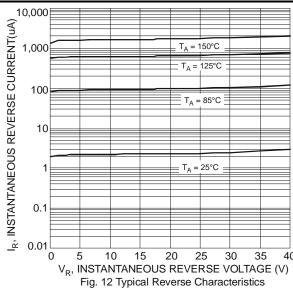
D1, SBR

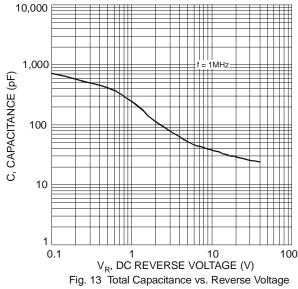


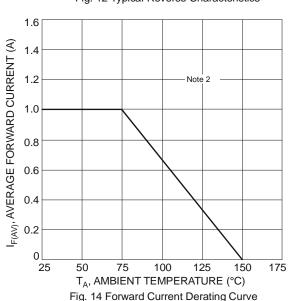


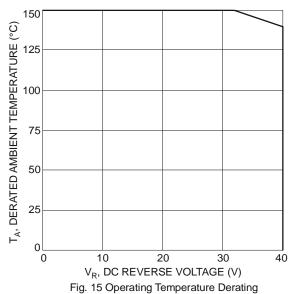


D1, SBR - Continued









Ordering Information (Note 6)

Part Number	Case	Packaging
DMS2120LFWB-7	DFN3020B-8	3000/Tape & Reel

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information

MF YM

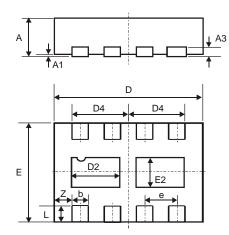
MF = Product Type Marking Code YM = Date Code Marking Y = Year (ex: V = 2008) M = Month (ex: 9 = September)

Date Code Key

Date Code Ite												
Year	2008		2009	2010		2011	2012	?	2013	2014		2015
Code	V		W	X		Υ	Z		Α	В		С
Month	Jan	Feb	Mar	Apr	May	/ Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

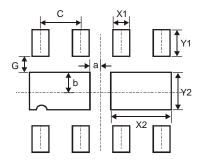


Package Outline Dimensions



	DFN3020B-8							
Dim	Min	Max	Тур					
Α	0.77	0.83	0.80					
A1	0	0.05	0.02					
А3	-	-	0.15					
b	0.25	0.35	0.30					
D	2.95	3.075	3.00					
D2	0.82	1.02	0.92					
D4	1.01	1.21	1.11					
е	-	-	0.65					
Е	1.95	2.075	2.00					
E2	0.43	0.63	0.53					
L	0.25	0.35	0.30					
Z	-	-	0.375					
All I	Dimens	sions ir	n mm					

Suggested Pad Layout



Dimensions	Value (in mm)
а	0.09
b	0.365
С	0.65
G	0.285
X1	0.4
X2	1.12
Y1	0.5
Y2	0.73

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